



# YJG4D4G04A

## N-Channel Enhancement Mode Field Effect Transistor

### Product Summary

|                                   |      |
|-----------------------------------|------|
| $V_{DS}$                          | 40V  |
| $I_D$                             | 80A  |
| $R_{DS(ON)}$ ( at $V_{GS}=10V$ )  | 4.4m |
| $R_{DS(ON)}$ ( at $V_{GS}=4.5V$ ) | 8m   |
| 100% EAS Tested                   |      |
| 100% $V_{DS}$ Tested              |      |

### General Description

Excellent package for heat dissipation  
 High density cell design for low  $R_{DS(ON)}$   
 Moisture Sensitivity Level 1  
 Epoxy Meets UL 94 V-0 Flammability Rating  
 Halogen Free

### Applications

Power switching application  
 Uninterruptible power supply  
 DC-DC convertor

### Limiting Values

| Parameter                              |                         | Symbol                                    | Min | Max  | Unit |    |
|--|-------------------------|---|-----|------|------|----|
| Drain-source Voltage                   |                         | $V_{DS}$                                  | -   | 40   | V    |    |
| Gate-source Voltage                    |                         | $V_{GS}$                                  | -20 | 20   | V    |    |
| Continuous Drain Current<br>(Note 1,2) | Steady-State            | $T_A=25$ , $V_{GS}=10V$                   | -   | 18   | A    |    |
|  |                         | $T_A=100$ , $V_{GS}=10V$                  | -   | 12.7 |      |    |
| Continuous Drain Current<br>(Note 1,3) | Steady-State            | $T_C=25$ , $V_{GS}=10V$ , Chip limitation | -   | 80   |      |    |
|  |                         | $T_C=100$ , $V_{GS}=10V$                  | -   | 56   |      |    |
| Pulsed Drain Current                   | $T_C=25$ , t 10 $\mu$ s | $I_{DM}$                                  | -   | 320  | A    |    |
| Avalanche energy (non-repetitive)      |                         | $V_G=10V$ , $R_G$ , L=0.5mH, IAS=15.5A    | EAS | -    | 60   | mJ |
| Total Power Dissipation<br>(Note 1,2)  | Steady-State            | $T_A=25$                                  | -   | 2.6  | W    |    |
|  |                         | $T_A=100$                                 | -   | 1.3  |      |    |
| Total Power Dissipation<br>(Note 1,3)  | Steady-State            | $T_C=25$                                  | -   | 51   |      |    |
|  |                         | $T_C=100$                                 | -   | 25   |      |    |



# YJG4D4G04A

## Electrical Characteristics ( $T_J=25$ unless otherwise noted)

| Parameter                         | Symbol       | Conditions                       | Min | Typ  | Max       | Units |
|-----------------------------------|--------------|----------------------------------|-----|------|-----------|-------|
| <b>Static Parameter</b>           |              |                                  |     |      |           |       |
| Drain-Source Breakdown Voltage    | $BV_{DSS}$   | $V_{GS}=0V, I_D$                 | 40  | -    | -         | V     |
|                                   |              | $V_{GS}=0V, I_D=10mA$            | 40  | -    | -         | V     |
| Zero Gate Voltage Drain Current   | $I_{DSS}$    | $V_{DS}=32V, V_{GS}=0V$          | -   | -    | 1         |       |
|                                   |              | $V_{DS}=32V, V_{GS}=0V, T_J=125$ | -   | -    | 100       |       |
| Gate-Body Leakage Current         | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$      | -   | -    | $\pm 100$ | nA    |
| Gate Threshold Voltage            | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D$             | 1.2 | 1.7  | 2.5       | V     |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=40A$            | -   | 3.3  |           |       |
|                                   |              | $V_{GS}=4.5V, I_D=20A$           | -   | 5.8  | 8         |       |
| Diode Forward Voltage             | $V_{SD}$     | $I_S=40A, V_{GS}=0V$             | -   | 0.85 | 1.2       | V     |

Gate resistance



# YJG4D4G04A

## Typical Electrical and Thermal Characteristics Diagrams

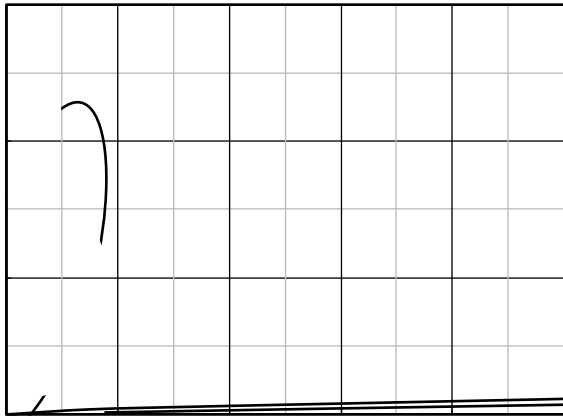


Figure 1. Output Characteristics

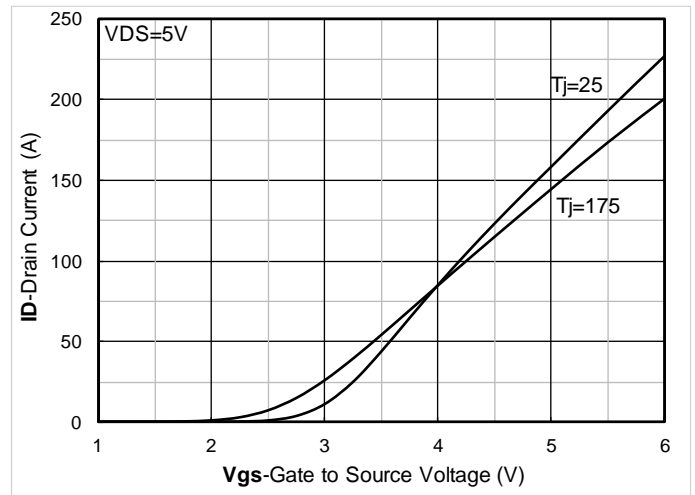


Figure 2. Transfer Characteristics

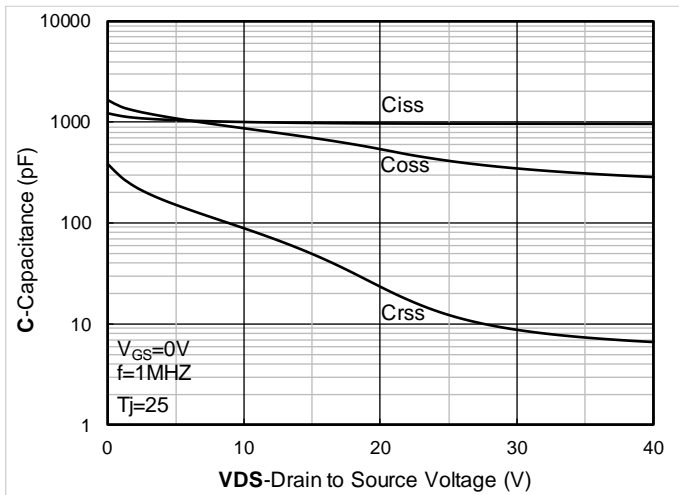


Figure 3. Capacitance Characteristics

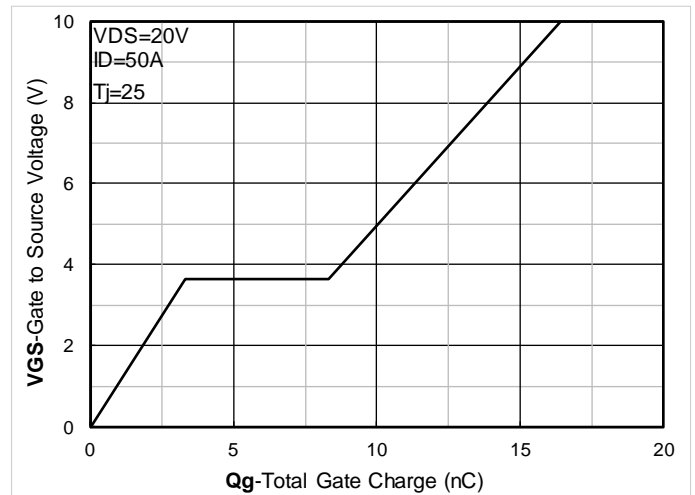


Figure 4. Gate Charge

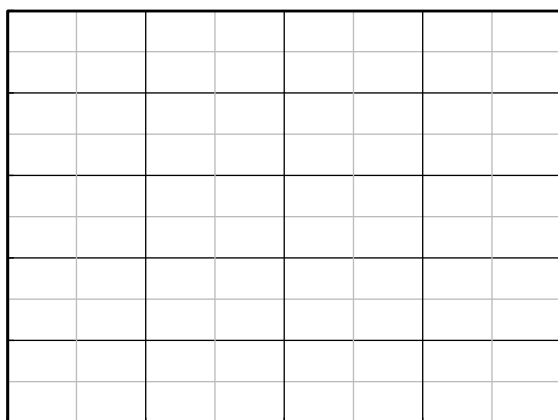
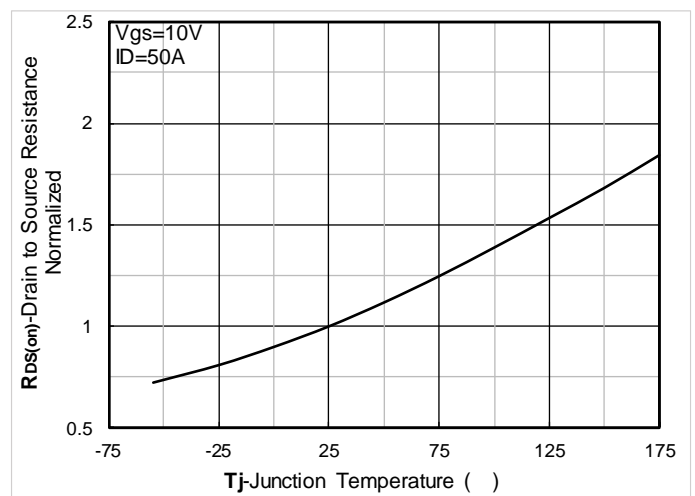


Figure 5. On-Resistance vs Gate to Source Voltage



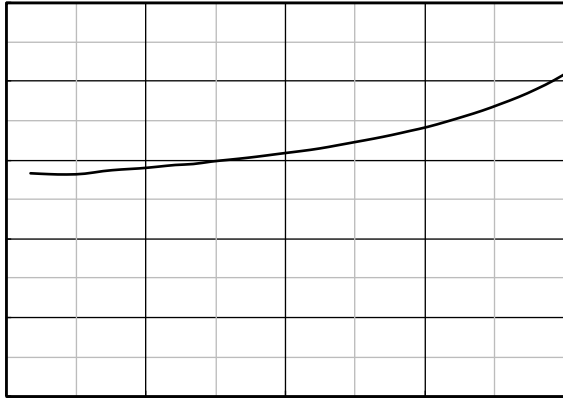


Figure 7.  $R_{DS(on)}$  VS Drain Current

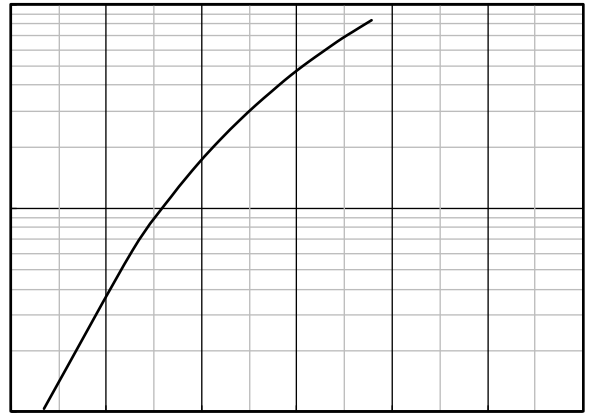


Figure 8. Forward characteristics of reverse diode

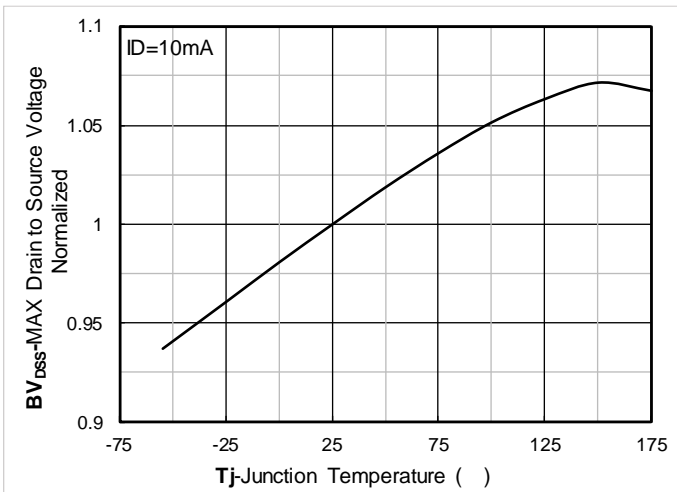


Figure 9. Normalized breakdown voltage

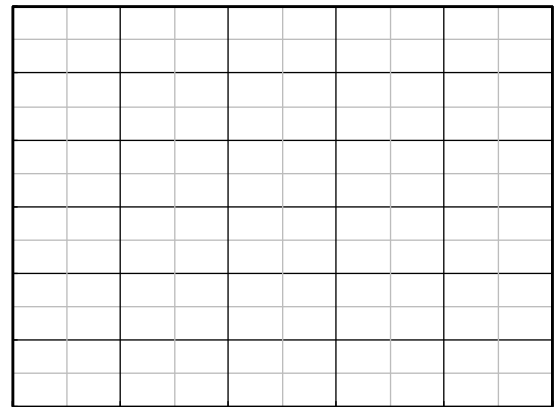
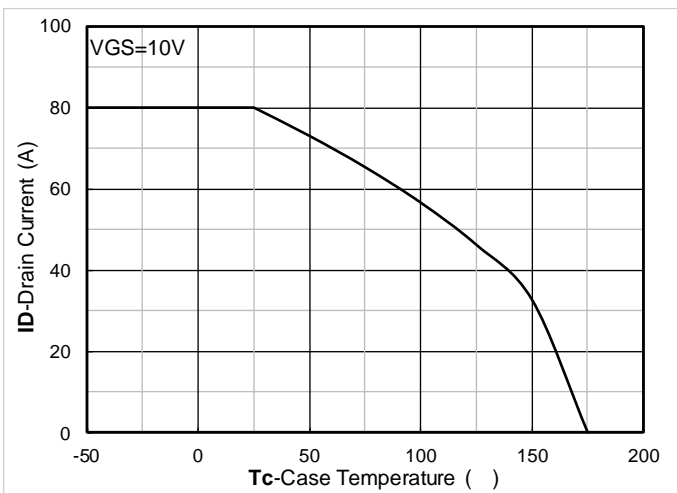


Figure 10. Normalized Threshold voltage





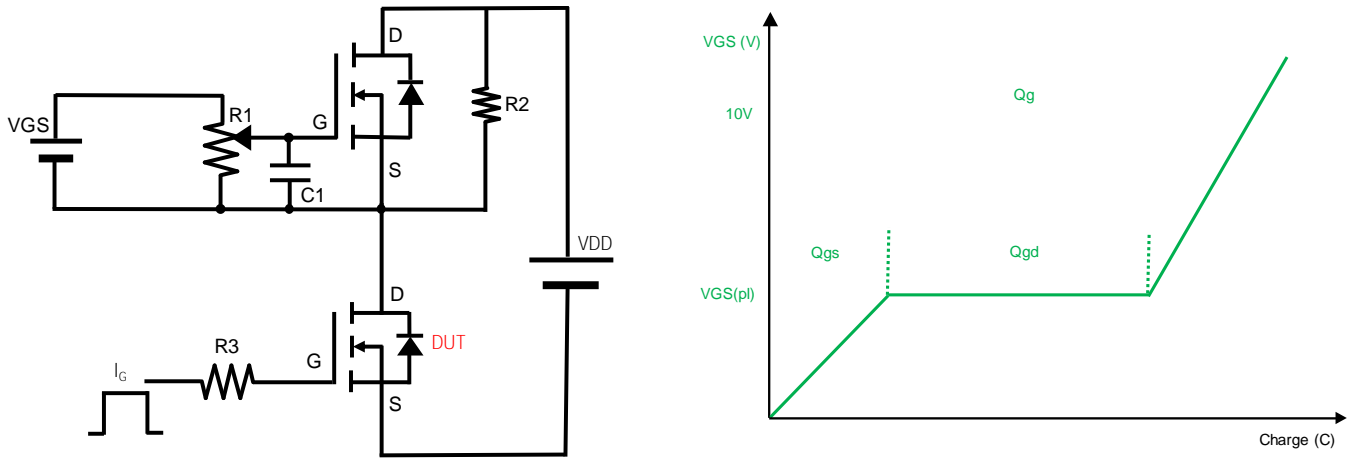


Figure B. Gate Charge Test Circuit & Waveform

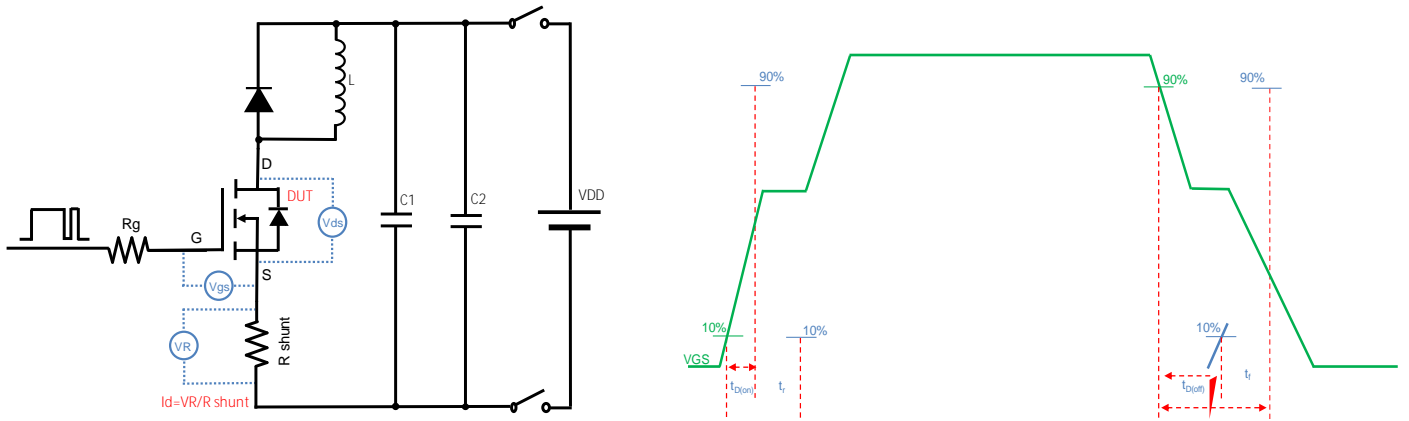


Figure C. Resistive Switching Test Circuit & Waveform

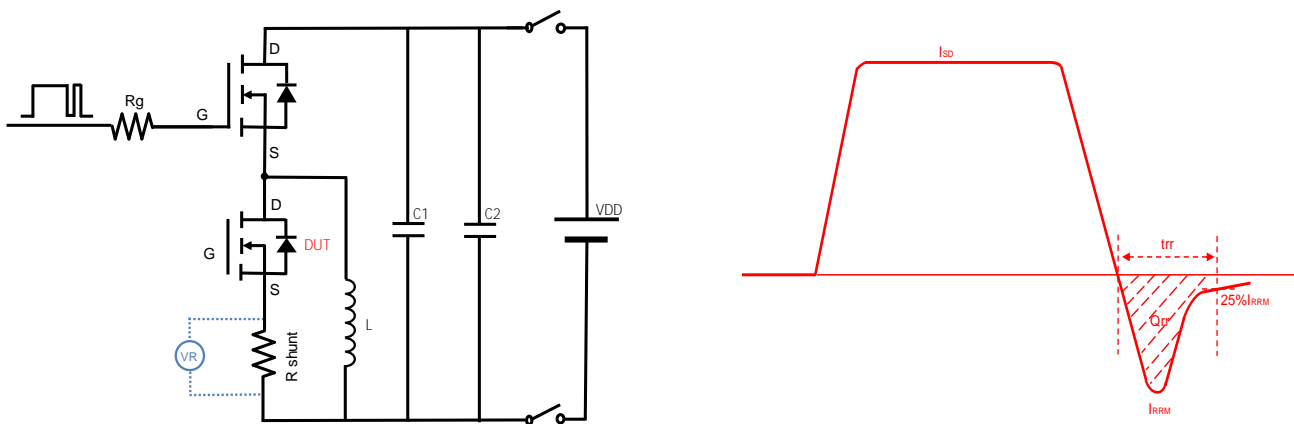


Figure D. Diode Recovery Test Circuit & Waveform



